

Advanced Power MOSFET

IRLS530A

FEATURES

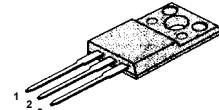
- Logic Level Gate Drive
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : $10 \mu\text{A}$ (Max.) @ $V_{DS} = 100\text{V}$
- Lower $R_{DS(\text{ON})}$: 0.101Ω (Typ.)

$BV_{DSS} = 100\text{ V}$

$R_{DS(\text{on})} = 0.12\ \Omega$

$I_D = 10.7\text{ A}$

TO-220F



1.Gate 2.Drain 3.Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	100	V
I_D	Continuous Drain Current ($T_C=25^\circ\text{C}$)	10.7	A
	Continuous Drain Current ($T_C=100^\circ\text{C}$)	7.5	
I_{DM}	Drain Current-Pulsed	49	A
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy	228	mJ
I_{AR}	Avalanche Current	10.7	A
E_{AR}	Repetitive Avalanche Energy	3.6	mJ
dv/dt	Peak Diode Recovery dv/dt	6.5	V/ns
P_D	Total Power Dissipation ($T_C=25^\circ\text{C}$)	36	W
	Linear Derating Factor	0.24	$\text{W}/^\circ\text{C}$
T_J, T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +175	$^\circ\text{C}$
	Maximum Lead Temp. for Soldering Purposes, 1/8 " from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	4.2	$^\circ\text{C}/\text{W}$
	Junction-to-Ambient	--	62.5	

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Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	100	--	--	V	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	0.1	--	$\text{V}/^\circ\text{C}$	$I_D=250\mu\text{A}$ See Fig 7
$V_{GS(\text{th})}$	Gate Threshold Voltage	1.0	--	2.0	V	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$
I_{GSS}	Gate-Source Leakage , Forward	--	--	100	nA	$V_{GS}=20\text{V}$
	Gate-Source Leakage , Reverse	--	--	-100		$V_{GS}=-20\text{V}$
I_{DSS}	Drain-to-Source Leakage Current	--	--	10	μA	$V_{DS}=100\text{V}$
		--	--	100		$V_{DS}=80\text{V}, T_C=150^\circ\text{C}$
$R_{DS(\text{on})}$	Static Drain-Source On-State Resistance	--	--	0.12	Ω	$V_{GS}=5\text{V}, I_D=5.35\text{A}$ ④
g_f	Forward Transconductance	--	9.2	--	S	$V_{DS}=40\text{V}, I_D=5.35\text{A}$ ④
C_{iss}	Input Capacitance	--	580	755	pF	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	--	140	175		
C_{rss}	Reverse Transfer Capacitance	--	60	75		
$t_{d(on)}$	Turn-On Delay Time	--	10	30	ns	$V_{DD}=50\text{V}, I_D=14\text{A}, R_G=6\Omega$ See Fig 13 ④ ⑤
t_r	Rise Time	--	11	30		
$t_{d(off)}$	Turn-Off Delay Time	--	29	70		
t_f	Fall Time	--	15	40		
Q_g	Total Gate Charge	--	16.9	24	nC	$V_{DS}=80\text{V}, V_{GS}=5\text{V}, I_D=14\text{A}$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	--	2.7	--		
Q_{qd}	Gate-Drain("Miller") Charge	--	9.7	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_s	Continuous Source Current	--	--	10.7	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	49		
V_{SD}	Diode Forward Voltage ④	--	--	1.5	V	$T_J=25^\circ\text{C}, I_S=10.7\text{A}, V_{GS}=0\text{V}$
t_{rr}	Reverse Recovery Time	--	109	--	ns	$T_J=25^\circ\text{C}, I_F=14\text{A}$ $dI_F/dt=100\text{A}/\mu\text{s}$ ④
Q_{rr}	Reverse Recovery Charge	--	0.41	--	μC	

Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=3\text{mH}, I_{AS}=10.7\text{A}, V_{DD}=25\text{V}, R_G=2\Omega, \text{Starting } T_J=25^\circ\text{C}$
- ③ $I_{SD}\leq 14\text{A}, di/dt\leq 350\text{A}/\mu\text{s}, V_{DD}\leq BV_{DSS}, \text{Starting } T_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = $250\mu\text{s}$, Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

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Fig 1. Output Characteristics

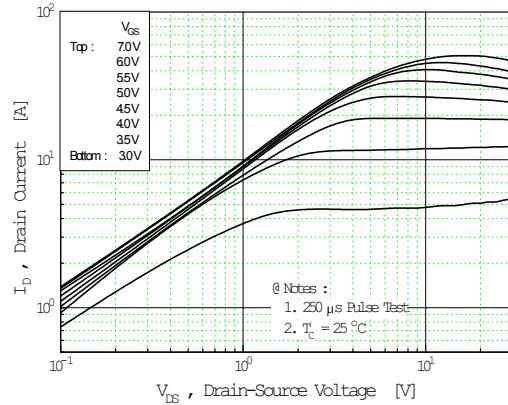


Fig 2. Transfer Characteristics

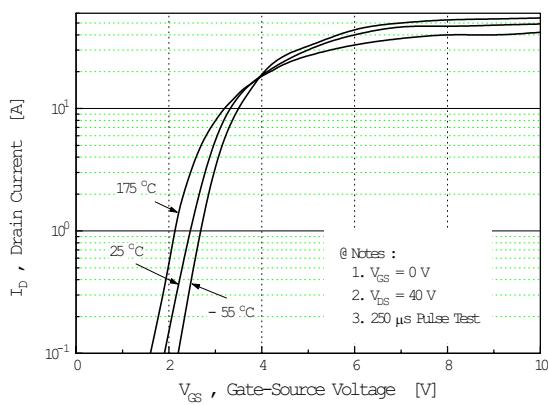


Fig 3. On-Resistance vs. Drain Current

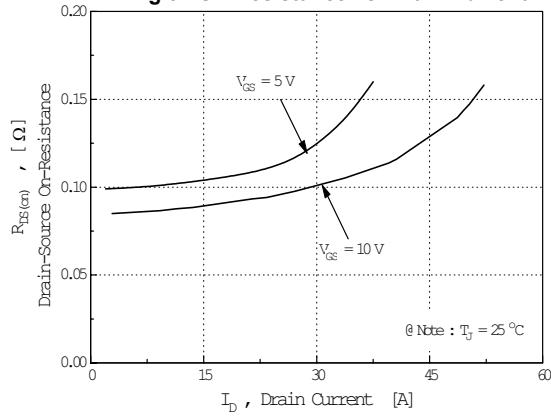


Fig 4. Source-Drain Diode Forward Voltage

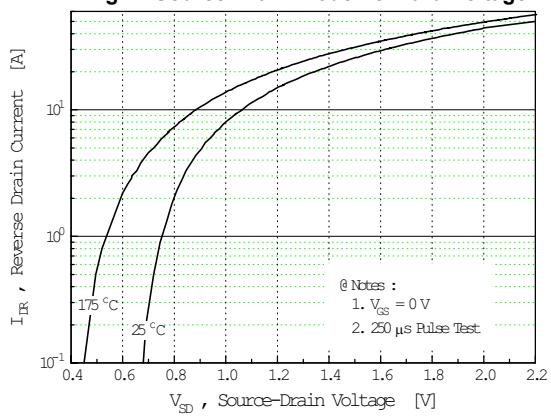


Fig 5. Capacitance vs. Drain-Source Voltage

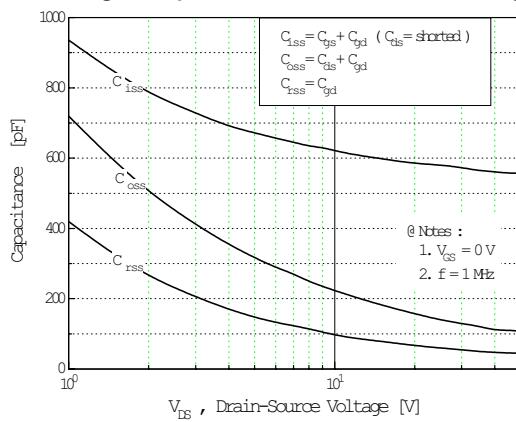
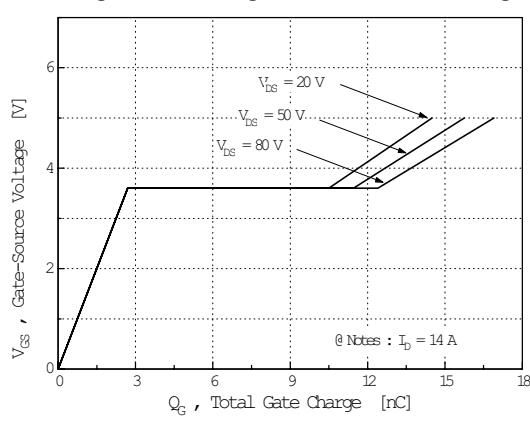


Fig 6. Gate Charge vs. Gate-Source Voltage



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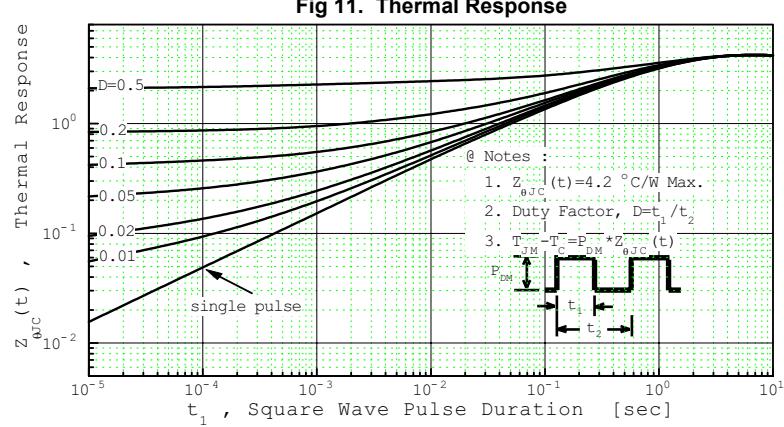
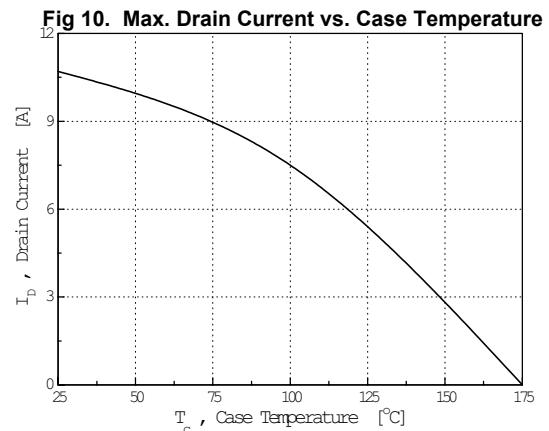
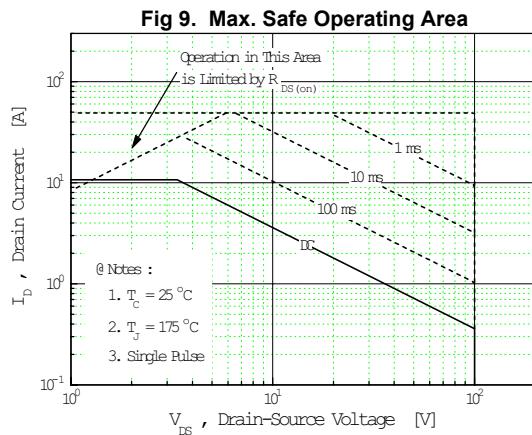
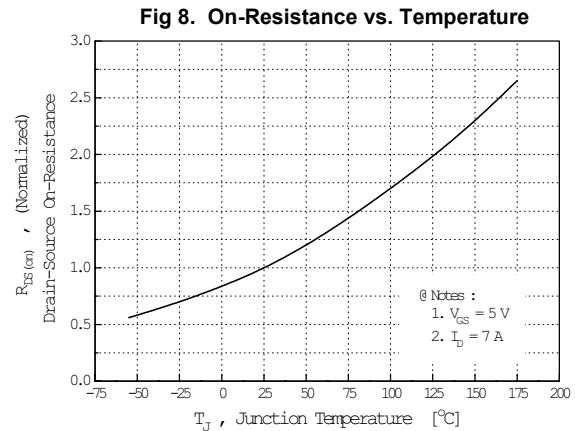
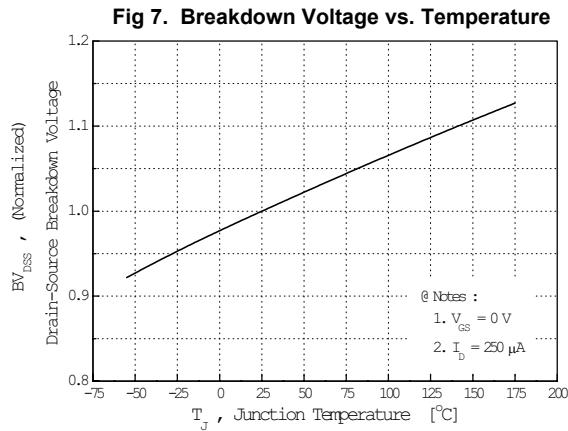


Fig 12. Gate Charge Test Circuit & Waveform

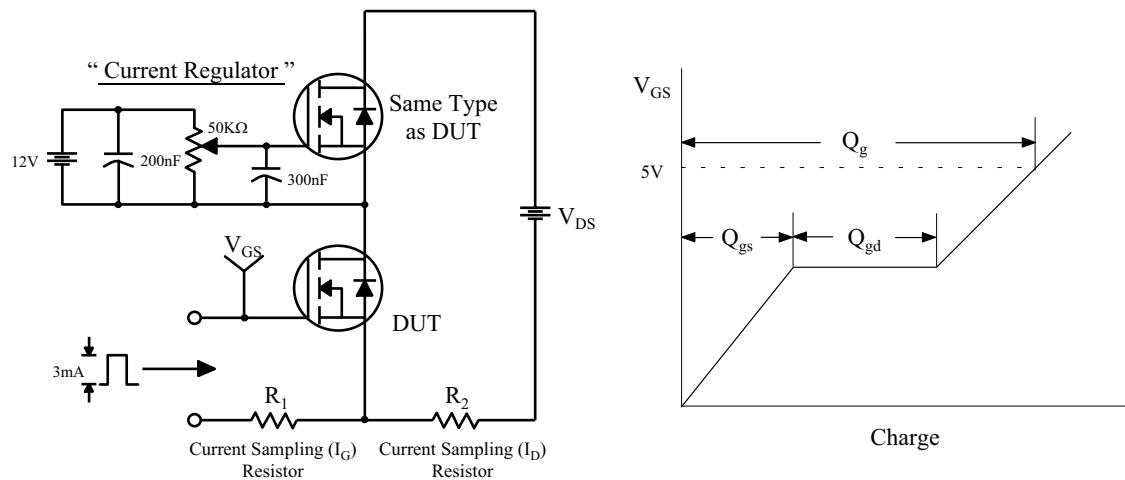


Fig 13. Resistive Switching Test Circuit & Waveforms

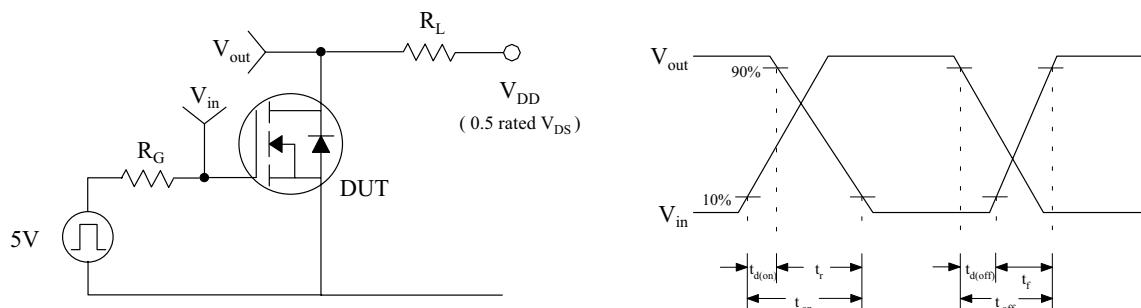
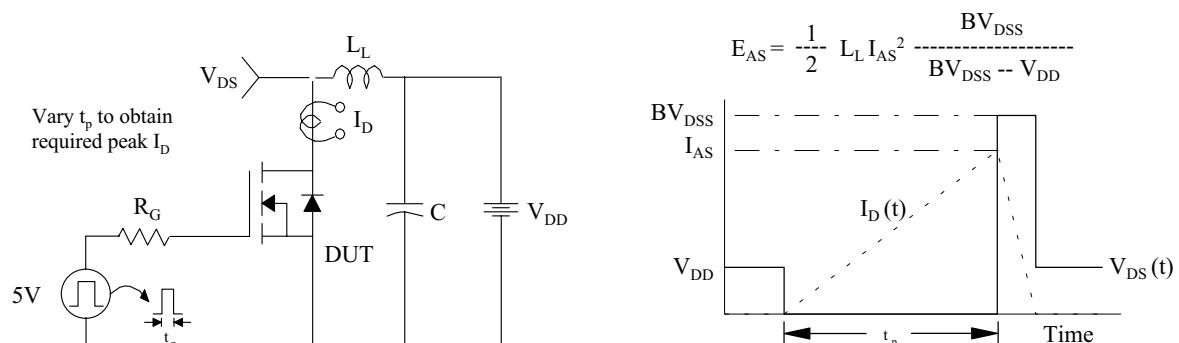


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



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Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

